

TSMC-01-660

10/083,991

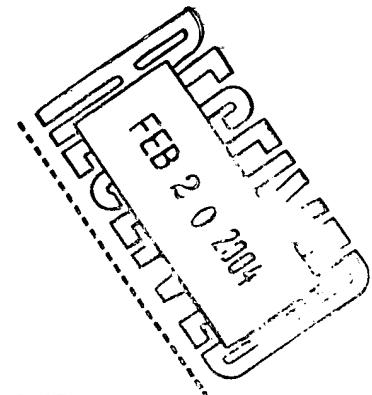
2812

January 5, 2004

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572
28 Davis Ave.
Poughkeepsie, NY 12603

SUBJECT: Serial #: 10/083,991
File Date: 02/26/2002
Inventor: Chia-Der Chang
Title: "PLANARIZATION METHOD FOR DEEP SUB
MICRON SHALLOW TRENCH ISOLATION
PROCESS"
Art Unit: 2812
Examiner: Stanetta D. Isaac



RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated November 7, 2003 please consider
the following arguments:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States
Postal Service as first class mail in an envelope addressed to: Commissioner for Patents,
P.O. Box 1450, Arlington, VA 22313-1450 on February 9, 2004.

Signature

Date:

2/9/04

Name

2/9/04

Amendments to the Specification: There are no Amendments to the Specification in this paper.

Amendments to the Claims: There are no Amendments to the Claims in this paper.

Amendments to the Drawings: There are no Amendments to the Drawings in this paper.

Remarks/Arguments: Remarks/Arguments begin on page 3 of this paper.